# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Kenichi OSADA	11/05/2007
Naoki KITAI	11/13/2007
Takayuki KAWAHARA	11/05/2007
Kazumasa YANAGISAWA	11/09/2007

#### **RECEIVING PARTY DATA**

Name:	Renesas Technology Corp.	
Street Address:	6-2, Otemachi 2-chome	
Internal Address:	Chiyoda-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	100-0004	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11915126

## **CORRESPONDENCE DATA**

Fax Number: (703)610-8686

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 7039039000

Email: IPDocketing@milesstockbridge.com

Correspondent Name: Mitchell W. Shapiro Address Line 1: 1751 Pinnacle Drive

Address Line 2: Suite 500

Address Line 4: McLean, VIRGINIA 22102

ATTORNEY DOCKET NUMBER:	XA-10937	
NAME OF SUBMITTER:	Mitchell W. Shapiro	

**PATENT** 500403342 **REEL: 020141 FRAME: 0040** 

Total Attachments: 1

source=Assignment#page1.tif

PATENT REEL: 020141 FRAME: 0041

## **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by RENESAS TECHNOLOGY CORP., a corporation organized under the laws of Japan, located at 6-2, Otemachi 2-chome, Chiyoda-ku, Tokyo 100-0004, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said RENESAS TECHNOLOGY CORP., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

#### SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said RENESAS TECHNOLOGY CORP., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said RENESAS TECHNOLOGY CORP..

Signed on the date(s) indicated aside signatures:

INVENTOR(S)	Date Signed
(発明者フルネームサイン)	(署名日)
1) Kemillov Osada (Kenichi	OSADA) 11/5/2007
2) Naoki Kitai (Nao	ki KITAI) 11 / 13 / 2007
3) Talcayuki Rawahana (Takayuki KAW	(AHARA) 11/5/2007
4) Cazamasa Yanajisawa (Kazumasa YANAG	/ .
5)	
6)	
7)	
8)	
9)	
0)	
Y/	

PATENT REEL: 020141 FRAME: 0042

**RECORDED: 11/20/2007**